

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCV540FK TC74VHCV541FK

Octal Schmitt Bus Buffer

TC74VHCV540FK Inverted, 3-State Outputs
TC74VHCV541FK Non-Inverted, 3-State Outputs

The TC74VHC540 and 541FK are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate CMOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

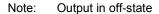
The TC74VHCV540FK is an inverting type, and the TC74VHCV541FK is a non-inverting type.

When either  $\overline{G}1~$  or  $\overline{G}2~$  are high, the terminal outputs are in the high-impedance state.

Input pin have hysteresis between the positive-going and negative-going

thresholds. Thus the TC74VHCV540 and 541FK are capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output (Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.





- High speed: tpd = 4.1 ns (typ.) at VCC = 5 V
- Low power dissipation: ICC = 2 μA (max) at Ta = 25°C
- Wide operating voltage range: VCC (opr) = 1.8 V to 5.5 V
- Ouput current: |IOH|/IOL = 16 mA (min) (VCC = 4.5 V)
- Available in VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 540/541 type

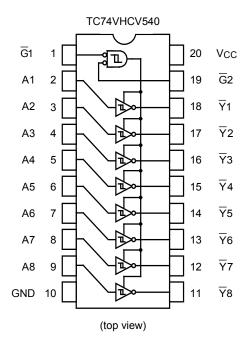


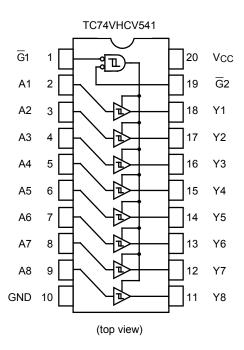
Weight VSSOP20-P-0030-0.50 : 0.03 g ( typ.)

Start of commercial production 2010-01



#### **Pin Assignment**





#### **Truth Table**

Inputs			Outputs			
G1	G2	An	Yn	$\overline{Y}_n$		
Н	Х	Х	Z	Z		
Х	Н	Х	Z	Z		
L	L	Н	Н	L		
L	L	L	L	Н		

X: Don't care

Z: High impedance

Yn: TC74VHCV541

Y<sub>n</sub>: TC74VHCV540



### **Absolute Maximum Ratings (Note1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vcc	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V	-0.5 to 7.0 (Note 2)	V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC V <sub>CC</sub> /ground current	ICC/IGND	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

#### **Operating Ranges (Note1)**

Characteristics	Symbol	Rating	Unit		
Power supply voltage	Vcc	1.8 to 5.5	V		
Input voltage	V <sub>IN</sub>	0 to 5.5	٧		
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 2)	.,		
		0 to V <sub>C</sub> C (Note 3)	V		
Operating temperature	Topr	-40 to 85	°C		
Input rise and fall time	dt/dv	0 to 20 (V <sub>CC</sub> = 3.3 ± 0.3V) 0 to 1 (V <sub>CC</sub> = 5 ± 0.5V)	ms/V		

Note 1: The operating ranges must be maintained to ensure the normal operation of the device..

Unused inputs must be tied to either VCC or GND.

Note 2: Output in OFF state

Note 3: High or low state



## **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition				Га = 25°C	)	Ta = -40 to 85°C		Unit	
Oyinboi				VCC (V)	Min	Тур.	Max	Min	Max	0	
		_		1.8	_	_	1.65	_	1.65		
				2.3	_	_	1.85	_	1.85		
Positive threshold voltage	VP			3.0	_	_	2.20	_	2.20		
				4.5	_	_	3.15	_	3.15		
				5.5		_	3.85		3.85	V	
				1.8	0.15	_	_	0.15	_	·	
				2.3	0.45	_	_	0.45	_		
Negative threshold voltage	VN	_		3.0	0.90	_	_	0.90	_		
				4.5	1.35	_	_	1.35	_		
				5.5	1.65	_	_	1.65			
	Vн	_		1.8	0.15	_	1.05	0.15	1.05	٧	
				2.3	0.20	_	1.10	0.20	1.10		
Hysteresis voltage				3.0	0.30	_	1.20	0.30	1.20		
				4.5	0.40	_	1.40	0.40	1.40		
				5.5	0.50	_	1.60	0.50	1.60		
	Vон	VIN = VIH or VIL	I <sub>OH</sub> = -50 μA	1.8	1.7	1.8	_	1.7	_		
				3.0	2.9	3.0	_	2.9	_		
High-level output voltage				4.5	4.4	4.5		4.4	_		
			I <sub>OH</sub> = -8 mA	3.0	2.58	_	_	2.48	_		
			IOH = −16 mA	4.5	3.94	_	_	3.80		V	
				1.8	_	0.0	0.1	_	0.1	-	
		VIN	I <sub>OL</sub> = 50 μA	3.0	_	0.0	0.1	_	0.1		
Low-level output voltage	Vol	= V <sub>IH</sub> or V <sub>IL</sub>		4.5		0.0	0.1		0.1	_	
			I <sub>OL</sub> = 8 mA	3.0	_	_	0.36	_	0.44		
			I <sub>OL</sub> = 16 mA	4.5	_	_	0.44	_	0.55		
3-state output off-state current	loz	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> VOUT = 0 to 5.5V		1.8 to 5.5	_	_	±0.5	_	±5.0	μΑ	
Power-off leakage current	loff	V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	_	0.5	_	5.0	μΑ	
Input leakage current	liN	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5		_	±0.1	_	±1.0	μА	
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or	V <sub>IN</sub> = V <sub>CC</sub> or GND		_		2.0	_	20.0	μА	



#### AC Characteristics (input: tr = tf = 3 ns)

Characteristics	Symbol	Tes	est Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
Characteristics	Gymbol		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	Onit
			2.5 ± 0.2	15	_	6.3	12.0	1.0	14.5	
				50	_	8.8	16.8	1.0	18.5	
Propagation delay time	$t_{pLH}$		22.02	15	_	5.2	7.0	1.0	8.5	
(TC74VHCV540)	t <sub>pHL</sub>	_	$3.3 \pm 0.3$	50	_	7.0	10.5	1.0	12.0	ns
			E 0 + 0 E	15	_	4.1	5.0	1.0	6.0	
			$5.0 \pm 0.5$	50	_	5.6	7.0	1.0	8.0	
			2.5 ± 0.2	15	_	6.2	11.3	1.0	13.5	
			2.5 ± 0.2	50	_	8.8	15.9	1.0	18.5	
Propagation delay time	t <sub>pLH</sub>		3.3 ± 0.3	15	_	5.0	7.0	1.0	8.5	20
(TC74VHCV541)	$t_{pHL}$	_	3.3 ± 0.3	50	_	6.9	10.5	1.0	12.0	ns
			5.0 ± 0.5	15	_	3.9	5.0	1.0	6.0	
				50	_	5.3	7.0	1.0	8.0	
	t <sub>p</sub> zL t <sub>p</sub> zH	R <sub>L</sub> = 1 kΩ	2.5 ± 0.2	15	_	7.9	17.4	1.0	21.0	- ns
				50	_	10.4	22.2	1.0	25.5	
3-state output enable			3.3 ± 0.3	15	_	6.4	10.5	1.0	12.5	
time				50	_	8.2	14.0	1.0	16.0	
			5.0 ± 0.5	15	_	4.9	7.2	1.0	8.5	
				50	_	6.3	9.2	1.0	10.5	
			2.5 ± 0.2	50	_	13.3	22.3	1.0	25.5	
3-state output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	$R_L = 1 \text{ k}\Omega$	$3.3 \pm 0.3$	50	_	11.4	15.4	1.0	17.5	ns
	φηΖ		$5.0 \pm 0.5$	50	_	8.9	10.5	1.0	11.5	
			2.5 ± 0.2	50	_	_	2.0	1	2.0	
Output to output skew	t <sub>osHL</sub> t <sub>osLH</sub>	(Note 1)	$3.3 \pm 0.3$	50	_	_	1.5		1.5	ns
			$5.0 \pm 0.5$	50	_	_	1.0	_	1.0	
Input capacitance	C <sub>IN</sub>				_	4	10	_	10	pF
Output capacitance	Cout	_		_	6	_	_	_	pF	
Power dissipation	C <sub>PD</sub>	TC74VHCV54	10		_	28	_	_	_	pF
capacitance (Note 2)	<u> </u>	TC74VHCV541		_	29	_	_	_	þΓ	

Note 1: Parameter guaranteed by design.

tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

ICC (opr) = CPD·VCC·fIN + ICC/8 (per bit)



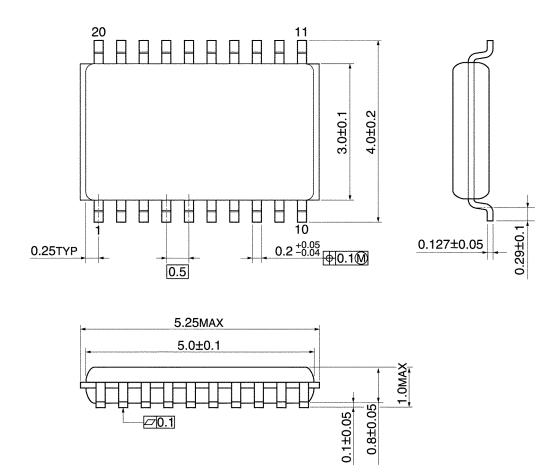
# Noise Characteristics (input: tr = tf = 3 ns)

Characteristics	Cumbal	Test Condition	Та		25°C	l lm:4
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Unit
Quiet output maximum dynamic VoL	Volp	C <sub>L</sub> = 50 pF	3.3	0.3	_	V
Quiet output maximum dynamic VOL	VOLP	СL = 30 рі	5.0	0.6		
Quiet output minimum dynamic VoL	Volv	C <sub>L</sub> = 50 pF	3.3	-0.1	-	V
Quiet output minimum dynamic VOL	VOLV	CL = 50 pr	5.0	-0.3	ı	
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	1	3.5	V
Maximum low level dynamic input voltage	VILD	C <sub>L</sub> = 50 pF	5.0	_	1.5	V



# **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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